



**Part Number :** [15913023](#)  
**Product Description :** 2.54mm Pitch SL Wire-to-Board Header, Low Profile, Surface Mount, Single Row, Right-Angle, 3.05mm Pocket, Shrouded, with Press-fit Plastic Peg, 2 Circuits, 0.76µm Gold (Au) Selective Plating, Tin (Sn) PC Tail Plating  
**Series Number :** 70634  
**Status :** Active  
**Product Category :** PCB Headers and Receptacles  
**Engineering Number :** 70634-0071



## Documents & Resources

### Drawings

[015913023 sd.pdf](#)  
[PK-70873-016-001.pdf](#)

### 3D Models and Design Files


[STEP AP242](#)  
[SOLIDWORKS](#)  
[Creo](#)

### Specifications

[PS-70400-001.pdf](#)  
[PS-70541-001.pdf](#)  
[TS-70541-100-001.pdf](#)

## Product Environment Compliance

### Compliance

GADSL/IMDS	Not Relevant
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC

	(25 June 2025)
EU RoHS	Compliant per EU 2015/863

#### Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

#### Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

#### Substances of Interest

- PFAS

#### EU RoHS Certificate of Compliance

#### Additional Product Compliance Information

## Part Details

### General

Status	Active
Category	PCB Headers and Receptacles
Series	70634
Description	2.54mm Pitch SL Wire-to-Board Header, Low Profile, Surface Mount, Single Row, Right-Angle, 3.05mm Pocket, Shrouded, with Press-fit Plastic Peg, 2 Circuits, 0.76µm Gold (Au) Selective Plating, Tin (Sn) PC Tail Plating
Application	Signal, Wire-to-Board
Component Type	PCB Header
Product Name	SL
UPC	800753771994

### Agency

CSA	LR19980
UL	E29179

## Electrical

Current - Maximum per Contact	3.0A
Voltage - Maximum	250V

## Physical

Breakaway	No
Circuits (Loaded)	2
Circuits (maximum)	2
Color - Resin	Black
Durability (mating cycles max)	50
Flammability	94V-0
Glow-Wire Capable	No
Lock to Mating Part	Yes
Material - Metal	Brass, Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	0.665/g
Number of Rows	1
Orientation	Right Angle
Packaging Type	Tube
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.60mm
Pitch - Mating Interface	2.54mm
Plating min - Mating	0.762µm
Plating min - Termination	1.905µm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Shrouded	Fully
Stackable	No
Temperature Range - Operating	-40° to +105°C
Termination Interface Style	Surface Mount

## Solder Process Data

Lead-Free Process Capability	REFLOW
Max-Temp	260

---

**Mates With / Use With**

**Mates with Part(s)**

Description	Part Number
SL Single Row Crimp Housings and CPA Retainers	<u>70066</u>
SL Single Row Female Insulation Displacement Connector Assemblies	<u>70400</u>
SL Single Row Female Receptacles	<u>70430</u>